

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Takayuki TSUKIZAWA et al.	Art Unit: 3729
Application No.: 10/596,312	
Confirmation No.: 5223	Examiner: T. Phan
Filing or 371(c) Date: June 8, 2006	
Title: METHOD FOR MANUFACTURING CHIP ELECTRONIC COMPONENT- MOUNTED CERAMIC SUBSTRATE (AS AMENDED)	

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated May 7, 2009, please amend the above-identified application as follows:

- Amendments to the Specification** begin on page **2** of this paper.
- Amendments to the Claims** are reflected in the listing of the claims which begins on page **4** of this paper.
- Amendments to the Drawings** begin on page _____ of this paper and include an attached replacement sheet. An **Appendix** including the amended drawing figures is attached following page _____ of this paper.
- Remarks/Arguments** begin on page **7** of this paper.

Please note, if a box is not checked, then no corresponding amendment is being made.